

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

Product image



















Similar to illustration

PCB terminal for fully automatic assembly in reflow soldering (SMT), with PUSH IN conductor connection system. Conductor inserted and slider operated in same direction (TOP). Packed in box or as tape on reel. Pin lengths optimised at 1.5 mm or 3.5 mm.

General ordering data

Version	Printed circuit board terminals, 3.50 mm, Number of poles: 5, 180°, PUSH IN, Clamping range, max. : 1.5 mm ²
Order No.	<u>2635630000</u>
Туре	LSF-SMT 3.50/05/180 3.5SN BK TU PRT
GTIN (EAN)	4050118650631
Qty.	30 pc(s).
Product data	IEC: 320 V / 17.5 A / 0.2 - 1.5 mm ² UL: 300 V / 12 A / AWG 28 - AWG 14



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Technical data

Dimensions and weights

Depth	7.8 mm	Depth (inches)	0.307 inch
Height of lowest version	14 mm	Net weight	3.667 g

Temperatures

Continuous operating temp., max. 120 °C

System parameters

Product family	OMNIMATE Signal - series	Wire connection method	
	LSF		PUSH IN
Mounting onto the PCB	THT/THR solder	Conductor outlet direction	
	connection		180°
Pitch in mm (P)	3.5 mm	Pitch in inches (P)	0.138 inch
Number of poles	5	Pin series quantity	1
Fitted by customer	No	Solder pin length tolerance	+0.1 / -0.3
Solder pin dimensions	0.35 x 0.8 mm	Solder pin dimensions = d tolerance	0 / -0.1 mm
Solder eyelet hole diameter (D)	1.1 mm	Solder eyelet hole diameter tolerance ((D)+ 0,1 mm
Number of solder pins per pole	2	Stripping length	8 mm
Touch-safe protection acc. to DIN VI	DE	Touch-safe protection acc. to DIN VDE	
0470	IP 20	57 106	Safe from finger touch
Volume resistance	1.60 mΩ		

Material data

Insulating material	LCP GF	Insulating material group	Illa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Copper alloy
Layer structure of solder connection	46 µm Sn matt	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	120 °C		

Conductors suitable for connection

Clamping range, min.	0.13 mm ²
Clamping range, max.	1.5 mm ²
Wire connection cross section AWG, min.	AWG 28
Wire connection cross section AWG, max.	AWG 14
Solid, min. H05(07) V-U	0.2 mm ²
Solid, max. H05(07) V-U	1.5 mm ²
Flexible, min. H05(07) V-K	0.2 mm ²
Flexible, max. H05(07) V-K	1.5 mm ²
w. plastic collar ferrule, DIN 46228 pt 4 min.	4, 0.25 mm²
w. plastic collar ferrule, DIN 46228 pt 4 max.	4, 0.75 mm²
w. wire end ferrule, DIN 46228 pt 1, min.	0.25 mm ²
w. wire end ferrule, DIN 46228 pt 1, max.	1.5 mm ²



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Clampable conductor	Cross-section for conductor connection		Туре	fine-wired
			nominal	0.25 mm ²
	wire end ferrule		Stripping length	nominal 10 mm
			Recommended wire end ferrule	H0,25/12 HBL
	Cross-section for conductor	r connection	Туре	fine-wired
			nominal	0.34 mm ²
	wire end ferrule		Stripping length	nominal 10 mm
			Recommended wire end ferrule	- <u>H0,34/12 TK</u>
	Cross-section for conductor connection		Туре	fine-wired
			nominal	0.5 mm ²
	wire end ferrule		Stripping length	nominal 10 mm
			Recommended wire end ferrule	
	Cross-section for conductor	r connection	Туре	fine-wired
			nominal	0.75 mm ²
	wire end ferrule		Stripping length	nominal 10 mm
			Recommended wire end ferrule	
Reference text	Length of ferrules is to be chosen depending on the product and the rated voltage., The outs diameter of the plastic collar should not be larger than the pitch (P)			ted voltage., The outsid
Rated data acc. to IEC				
tested acc. to standard	IEC 60664-1, IEC 61984	(Tu=20°C)	in. number of poles	17.5 A
Rated current, max. number of poles (Tu=20°C)	16 A	(Tu=40°C)	in. number of poles	17.5 A
Rated current, max. number of poles (Tu=40°C)	14 A	pollution degree		320 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	pollution degree		160 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2 2.5 k		2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	Short-time withstand current resistance 2.5 kV		tand current resistance	3 x 1s with 80 A
Rated data acc. to CSA				
Rated voltage (Use group B / CSA)	300 V	Rated voltage (U	se group D / CSA)	300 V
Rated current (Use group B / CSA)	10 A		se group D / CSA)	10 A
Wire cross-section, AWG, min.	AWG 28	Wire cross-section		AWG 14
Rated data acc. to UL 1059				
B . I	000.1/	D	D (111 40E2)	000.1/
Rated voltage (Use group B / UL 1059)	300 V		se group D / UL 1059)	
Rated current (Use group B / UL 1059) Wire cross-section, AWG, min.	12 A AWG 28	Rated current (U Wire cross-section	se group D / UL 1059) on, AWG, max.	10 A AWG 14
Packing	20	77110 01000 000110	, , G,an.	
VPE length	555 mm	VPE width		20 mm
VI L longtii				



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Classifications

ETIM 6.0	EC002643	ETIM 7.0	EC002643
ECLASS 9.0	27-44-04-01	ECLASS 9.1	27-44-04-01
ECLASS 10.0	27-44-04-01	ECLASS 11.0	27-46-01-01

Important note

Notes

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized
	standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties
	in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.

- Additional push button colours on request
- Operating force of slider max. 40 N
- Rated current related to rated cross-section & min. No. of poles.
- Wire end ferrule with plastic collar to DIN 46228/4
- Wire end ferrule without plastic collar to DIN 46228/1
- P on drawing = pitch
- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- Crimping shape "A" for wire end ferrules with PZ 6/5 crimping tool recommended.
- Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

Approvals

Approvals



ROHS Conform

Downloads

Brochure/Catalogue Catalogues in PDF-format



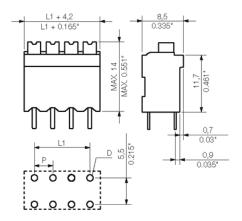
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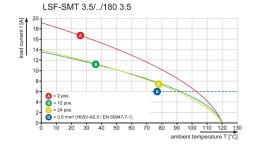
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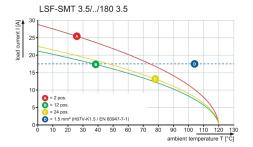
Drawings

Dimensional drawing



Graph Graph





80,50 3,169

3,031

2,894

2,756

2,618

2,480

2,343

2,205

2,067

1,929

1,791

1,654

1,516

1,378

1,240

1,102

0,965

0,827

0,689

0,551

0,413

0,276

0,138

Issue no

7358

77.00

73,50

70,00

66,50

63,00

59,50

56,00

52,50

49,00

45,50

42,00

38,50

35,00

31,50

28,00

24,50

21,00

17,50

14,00

10,50

7,00

3,50

n L1 [mm] L1 [lnch]

34084 (15)

Sheet 01 of 07 sheets

23 22

21

20

19

18

17

16

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14

13

12

11

10

9

8

6

5

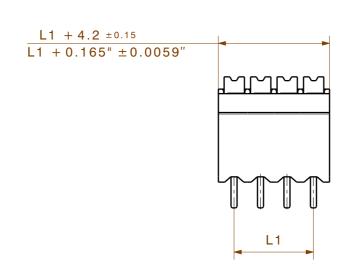
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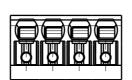
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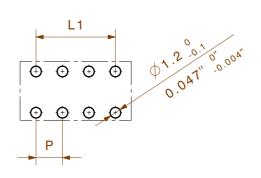
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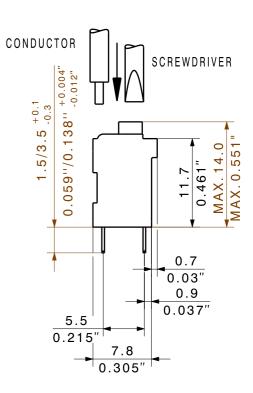


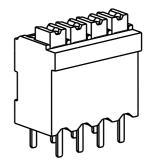


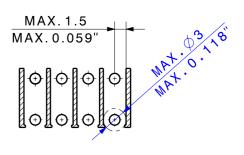




HOLE PATTERN







PASTE-FREE AREA

P = 3.50

SHOWN: LSF-SMT 3.50/04/180

For the mounting on PCBs, it should be noted that the rated data relates only to the PCB components

alone.
The neccessary creepage and clearance paths must be observed in the relevnt equipment standards in accordance with IEC 664 / VDE 0110.

The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3.

Weidmüller PCB components are rated in accordance with the DIN EN 61984 standard, and are valid for its field of

If the components are used in accordance with the intended purpose, the components will meet all requirements with respect to the occuring of electrical, mechanical, thermic and corrosive stress.

ROHS DIN ISO 2768-m	m			Cat.no.:.
ROMS DIN ISO 2768-	98688/5 23.10.17 HEL	IS_MA 00	We	eidmüller 🐔 3 34084
	Modifi	cation		Sheet 01 of 07
		Date	Name	
	Drawn	22.06.2004	SEIDEL_T	LSF-SMT//180TU
	Responsible		KRUG_M	LEITERPLATTENKLEMME
Scale: 5/1	Checked	01.11.2017	HELIS_MA	PCB TERMINAL
Supersedes: .	Approved		HECKERT_M	Product file: LSF-SMT



Recommended wave solderding profiles

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Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.



Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.